

UNITED STATES PATENT AND TRADEMARK OFFICE

ENITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, Virginia 22313-1450 www.uspto.gov

| APPLICATION NO. | PLICATION NO. FILING DATE | | FIRST NAMED INVENTOR | ATTORNEY DOCKET NO. | CONFIRMATION NO | |
|--|---------------------------|------------|----------------------|---|-----------------|--|
| 10/791,194 03/02/2004 | | /2004 | Frank L. Hall | 4718.2US (00-0316.02/US) | 1948 | |
| 24247 | 7590 | 09/27/2004 | | EXAMINER | | |
| TRASK BRITT | | | | HEINRICH, SAMUEL M | | |
| P.O. BOX 2550 SALT LAKE CITY, UT 84 | | 34110 | | ART UNIT | PAPER NUMBER | |
| | | | | 1725 | | |
| | | | | 22 4 2021 4 4 4 12 KID 00 (0.00 (0.00) | | |

DATE MAILED: 09/27/2004

Please find below and/or attached an Office communication concerning this application or proceeding.

| | | | | y,~ | | | |
|---|--|---|---|-----------|--|--|--|
| | Applicati | on No. | Applicant(s) | V | | | |
| Office Action Comme | 10/791,1 | 94 | HALL, FRANK L. | | | | |
| Office Action Summary | Examine | | Art Unit | | | | |
| | Samuel M | · · | 1725 | | | | |
| The MAILING DATE of this communication Period for Reply | n appears on the | e cover sheet with the d | correspondence addres | :s | | | |
| A SHORTENED STATUTORY PERIOD FOR R THE MAILING DATE OF THIS COMMUNICAT - Extensions of time may be available under the provisions of 37 of after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days - If NO period for reply is specified above, the maximum statutory. - Failure to reply within the set or extended period for reply will, by Any reply received by the Office later than three months after the earned patent term adjustment. See 37 CFR 1.704(b). | ON. FR 1.136(a). In no ev on. , a reply within the stat period will apply and w statute, cause the app | ent, however, may a reply be tin utory minimum of thirty (30) day ill expire SIX (6) MONTHS from lication to become ABANDONE | nely filed s will be considered timely. the mailing date of this commul D (35 U.S.C. § 133) | nication. | | | |
| Status | | | | | | | |
| 1) Responsive to communication(s) filed on | · | | | | | | |
| 2a) ☐ This action is FINAL . 2b) ☑ This action is non-final. | | | | | | | |
| 3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is | | | | | | | |
| closed in accordance with the practice under Ex parte Quayle, 1935 C.D. 11, 453 O.G. 213. | | | | | | | |
| Disposition of Claims | | | | | | | |
| 4)⊠ Claim(s) <u>1-6</u> is/are pending in the applica | tion. | | | | | | |
| 4a) Of the above claim(s) is/are wit | | nsideration. | | | | | |
| 5) Claim(s) is/are allowed. | | | | | | | |
| 6)⊠ Claim(s) <u>1-6</u> is/are rejected. | | | | | | | |
| 7) Claim(s) is/are objected to. | | | | | | | |
| 8) Claim(s) are subject to restriction a | and/or election re | equirement. | | | | | |
| Application Papers | | | | | | | |
| 9)☐ The specification is objected to by the Exa | miner. | | | | | | |
| 10)⊠ The drawing(s) filed on <u>02 March 2004</u> is/a | are: a)⊠ accep | ted or b)☐ objected to | by the Examiner. | | | | |
| Applicant may not request that any objection to | | | | | | | |
| Replacement drawing sheet(s) including the co | orrection is require | ed if the drawing(s) is obj | ected to. See 37 CFR 1. | 121(d). | | | |
| 11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152. | | | | | | | |
| Priority under 35 U.S.C. § 119 | | | | | | | |
| 12) Acknowledgment is made of a claim for for a laim for for for for a laim for | reign priority und | der 35 U.S.C. § 119(a) | -(d) or (f). | | | | |
| 1. Certified copies of the priority documents have been received. | | | | | | | |
| 2. Certified copies of the priority documents have been received in Application No | | | | | | | |
| 3. Copies of the certified copies of the priority documents have been received in this National Stage | | | | | | | |
| application from the International Bureau (PCT Rule 17.2(a)). | | | | | | | |
| * See the attached detailed Office action for a list of the certified copies not received. | | | | | | | |
| | | | | | | | |
| Attachment(s) | | | | | | | |
| 1) Notice of References Cited (PTO-892) | | 4) Interview Summary | (PTO-413) | | | | |
| 2) Notice of Draftsperson's Patent Drawing Review (PTO-94) | 3) | Paper No(s)/Mail Da | te | | | | |
| 3) Information Disclosure Statement(s) (PTO-1449 or PTO/S Paper No(s)/Mail Date 3/04 & 6/04. | B/08) | 5) Notice of Informal Page 6) Other: | atent Application (PTO-152) | ı | | | |
| J.S. Palent and Trademark Office | A-4! O | | | | | | |
| PTOL-326 (Rev. 1-04) Offi | ce Action Summa | y Pai | t of Paper No./Mail Date 09 | 232004 | | | |

Application/Control Number: 10/791,194

Art Unit: 1725

DETAILED ACTION

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

Claims 1-6 are rejected under 35 U.S.C. 102(b) as being anticipated by USPN

5,104,480 to Wojnarowski et al. Wojnarowski et al describe ABTX (1)

"A two layer metallization comprising a first, thermally inefficient reactive metal and a second UV light absorbing metal is preferred. When disposed on a thermally inefficient substrate, this two layer metallization ablates reactively as the two layers burn off together. This laser ablation process substantially roughens the surface of polymer dielectrics and may be used to repair open traces in printed circuit structures."

Wojnarowski et al also describe BSTX (24)

"Where the substrate is a polymer and the first layer is titanium or chrome and the second layer is copper, the portion of the polymer surface from which the metals were ablated is greatly roughened. If a subsequent dielectric layer is formed on top of this roughened surface by applying a liquid precursor and drying or curing it, then adhesion between the two layers is greatly enhanced by a resulting interlocking of the newly deposited dielectric layer with the roughened surface of the substrate."

Claims 1-6 are rejected under 35 U.S.C. 102(b) as being anticipated by USPN

4,894,115 to Eichelberger et al. Eichelberger et al describe

DETX (7)

"The via holes produced by the laser beam are cleaned by a short plasma etch cycle which removes from underlying metal pad 240 any particles formed during the laser beam scanning, such as soot, any residual polymer, or any glass that may be residual from any glass removal operation performed when etching a pad

Art Unit: 1725

mask, and cleans and roughens the upper surface of dielectric polymer layer 202 in order to enhance adhesion of subsequent metallization."

Conclusion

The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. The cited art pertains to roughening a surface with a laser.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Samuel M Heinrich whose telephone number is 571-272-1175. The examiner can normally be reached on M-F.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Thomas G Dunn can be reached on 571-272-1171. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Samuel M. Henrich 09-23-2004

Samuel M Heinrich Primary Examiner Art Unit 1725